Spin-on Glass NDG-2000

<table>
<thead>
<tr>
<th>Elements of Interest</th>
<th>Key Element atoms/cm³</th>
<th>Key Element % in Film</th>
</tr>
</thead>
<tbody>
<tr>
<td>Si, O</td>
<td>N/A</td>
<td>N/A</td>
</tr>
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<thead>
<tr>
<th>Viscosity</th>
<th>Thickness</th>
<th>Shelf Life</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.90 +/- 0.15 cps</td>
<td>Coats 2000 Å (200 nm) at 4000 rpm</td>
<td>20°C 3 months 4°C 9 months</td>
</tr>
</tbody>
</table>

Benefits
- Simple method to add Oxide layers
- Low temperature approach to silicon oxide layer formation
- Lower Maintenance and Cost of Ownership
- High purity materials
- Uniform Coatings
- Basic composition that other elements can be easily added to
- Stable Processing Independent of Flow Rates

Typical Application
This is a non-doping glass that is used for coating with a silica film (SiO₂). When baked at 250°C it gives a low density film that continues to become increasingly dense as bakes continue to 600°C or higher. We recommend baking at least as the highest temperature in the process. The lower density materials work well for bonding processes.

The silica formed films have high melting points. Other elements can be added to lower the melting point if that is desired. Sometimes elements are added to change the refractive index or other properties.

Packaging
- 240ml
- 500ml
- 1 l
- 2.5 l
- 4 l

Alternative Products
- NDG-5000
- NDG-7000

Alternate Elements
- Pb
- Ge
- Bismuth
- Tin
- Blends of two or more elements
- Other elements available for compound semiconductor use
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